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- Flexible sheet reinforced with poly(aromatic amide) non-woven fabric and use thereof.
- (57) A flexible sheet which comprises a non-woven fabric made predominantly from a poly(aromatic amide) component which is impregnated with a heat- and/or light-curable resin, wherein the non-woven fabric satisfies the following conditions:

 $5g/m^2$ < weight per unit area < $35 g/m^2$, and $0.15 g/cm^3 \le density \le 0.8 g/cm^3$,

which was well balanced properties, such as excellent heat dimensional stability, heat resistance (soldering resistance), water resistance, solvent resistance, electrical insulating properties and mechanical properties and is useful for the preparation of a flexible printed circuit board, and use thereof for a flexible metal-clad laminate and a flexible printed circuit board.



EUROPEAN SEARCH REPORT

Application Number

86 10 0824 ΕP

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·		SIDERED TO BE RELEV	'ANT	
Category	Citation of document with of relevant	i indication, where appropriate, passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int. Cl.4)
A	US-A-3 878 316 (6 * Claims 1-4,8; co column 3, line 45; column 8, line 45;	lumn 2, line 43 - column 5. line 17 -	1-10	D 04 H 1/42 D 21 H 5/20 H 05 K 1/03
Α	DE-A-2 600 209 (M * Claims 1,3-7; pa page 6, paragraph	ge 10. paragraph 1 -	1-3	
A	Columbus, Ohio. US	, vol. 93, no. 76, stract no. 214369w, ; & JP-A-80 85 094, RKS, LTD) 26-06-1980	1,2,10	·
		·		TECHNICAL FIELDS SEARCHED (Int. Cl.4)
				D 04 H H 05 K D 21 H
	The present search report has	haan drawn yn fan - W - L-		
	Place of search	Date of completion of the search		
THE	HAGUE	10-03-1989	i	Examiner BAND I.

FPO FORM 1503 03.82 (P0401)

X: particularly relevant if taken alone
Y: particularly relevant if combined with another document of the same category
A: technological background
O: non-written disclosure
P: intermediate document

after the filing date

D: document cited in the application

L: document cited for other reasons

&: member of the same patent family, corresponding document